# FAIRCHILD

SEMICONDUCTOR®

### November 2009

# ISL9V2540S3ST EcoSPARK® N-Channel Ignition IGBT 250mJ, 400V

### Features

- SCIS Energy = 250mJ at T<sub>J</sub> = 25°C
- Logic Level Gate Drive
- Qualified to AEC Q101
- RoHS Compliant

### **Applications**

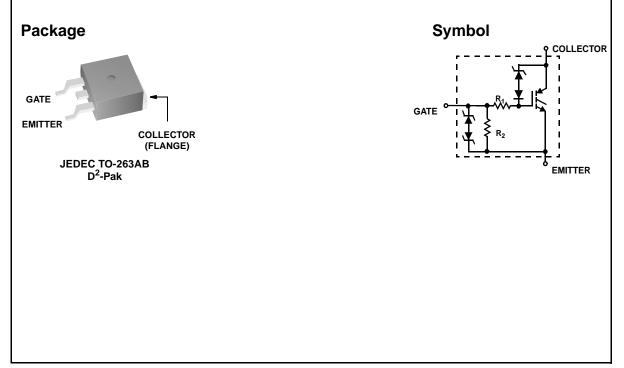
- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications

### **General Description**

The ISL9V2540S3ST is a next generation ignition IGBT that offers outstanding SCIS capability in the industry standard D<sup>2</sup>-Pak (TO-263) plastic package. This device is intended for use in automotive ignition circuits, specifically as a coil driver. Internal diodes provide voltage clamping without the need for external components.

**EcoSPARK**® devices can be custom made to specific clamp voltages. Contact your nearest Fairchild sales office for more information.





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Symbol	Parameter	Ratings	Units
BV <sub>CFR</sub>	Collector to Emitter Breakdown Voltage (I <sub>C</sub> = 1 mA)	430	V
BV <sub>FCS</sub>	Emitter to Collector Voltage - Reverse Battery Condition (I <sub>C</sub> = 10 mA)	24	V
E <sub>SCIS25</sub>	At Starting $T_J = 25^{\circ}$ C, $I_{SCIS} = 12.9$ A, L = 3.0mHy	250	mJ
ESCIS150	At Starting T <sub>J</sub> = 150°C, I <sub>SCIS</sub> = 10A, L = 3.0mHy	150	mJ
I <sub>C25</sub>	Collector Current Continuous, At T <sub>C</sub> = 25°C, See Fig 9	15.5	А
I <sub>C110</sub>	Collector Current Continuous, At T <sub>C</sub> = 110°C, See Fig 9	15.3	Α
V <sub>GEM</sub>	Gate to Emitter Voltage Continuous	±10	V
PD	Power Dissipation Total $T_{C} = 25^{\circ}C$	166.7	W
	Power Dissipation Derating $T_{C} > 25^{\circ}C$	1.11	W/℃
TJ	Operating Junction Temperature Range	-40 to 175	C
T <sub>STG</sub>	Storage Junction Temperature Range	-40 to 175	C
Τ <sub>Ι</sub>	Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)	300	C
Tpkg	Max Lead Temp for Soldering (Package Body for 10s)	260	C
ESD	Electrostatic Discharge Voltage at 100pF, 1500 $\Omega$ (HBM)	4	kV

# Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
V2540S	ISL9V2540S3ST	TO-263AB	330mm	24mm	800 units

## **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Con	ditions	Min	Тур	Мах	Units
ff State	Characteristics						_
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage	I <sub>C</sub> = 2mA, V <sub>GE</sub> = R <sub>G</sub> = 1KΩ, See T <sub>.1</sub> = -40 to 150°	e Fig. 15	370	400	430	V
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$I_{C} = 10$ mA, $V_{GE} = 0$ , $R_{G} = 0$ , See Fig. 15 $T_{1} = -40$ to 150°C		390	420	450	V
BV <sub>ECS</sub>	Emitter to Collector Breakdown Voltage	$I_{C} = -75$ mA, $V_{GE} = 0$ V, $T_{C} = 25$ °C		30	-	-	V
BV <sub>GES</sub>	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 2mA$		±12	±14	-	V
I <sub>CER</sub>	Collector to Emitter Leakage Current	V <sub>CER</sub> = 250V,	T <sub>C</sub> = 25°C	-	-	25	μA
		R <sub>G</sub> = 1KΩ, See Fig. 11	T <sub>C</sub> = 150°C	-	-	1	mA
I <sub>ECS</sub>	Emitter to Collector Leakage Current	V <sub>EC</sub> = 24V, See	T <sub>C</sub> = 25°C	-	-	1	mA
		Fig. 11	T <sub>C</sub> = 150°C	-	-	40	mA
R <sub>1</sub>	Series Gate Resistance			-	70	-	Ω
$R_2$	Gate to Emitter Resistance			10K	-	26K	Ω
n State	Characteristics						
$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_{\rm C} = 6A,$	T <sub>C</sub> = 25°C,	-	1.37	1.8	V

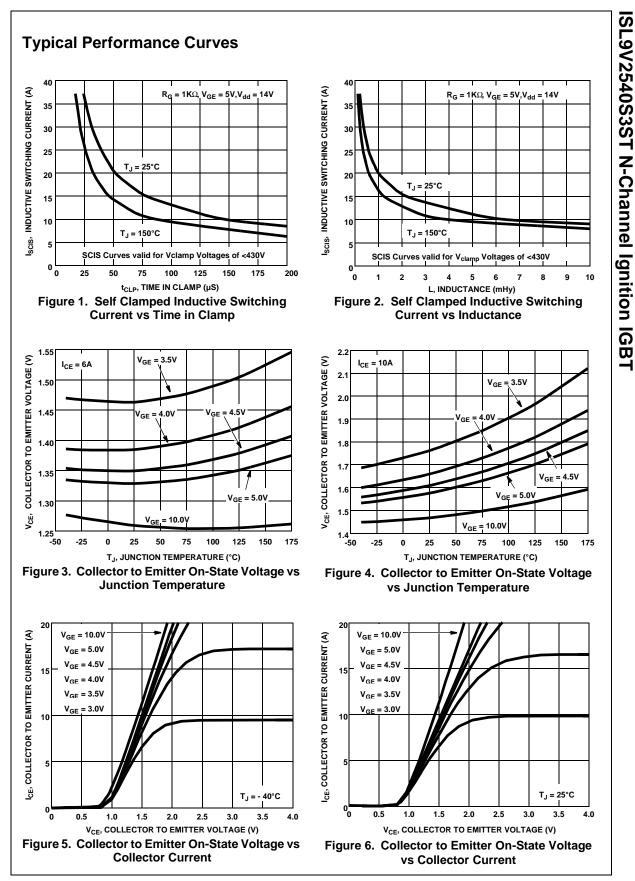
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 6A, V <sub>GF</sub> = 4V	T <sub>C</sub> = 25°C, See Fig. 3	-	1.37	1.8	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 10A, V <sub>GE</sub> = 4.5V	T <sub>C</sub> = 150℃ See Fig. 4	-	1.77	2.2	V



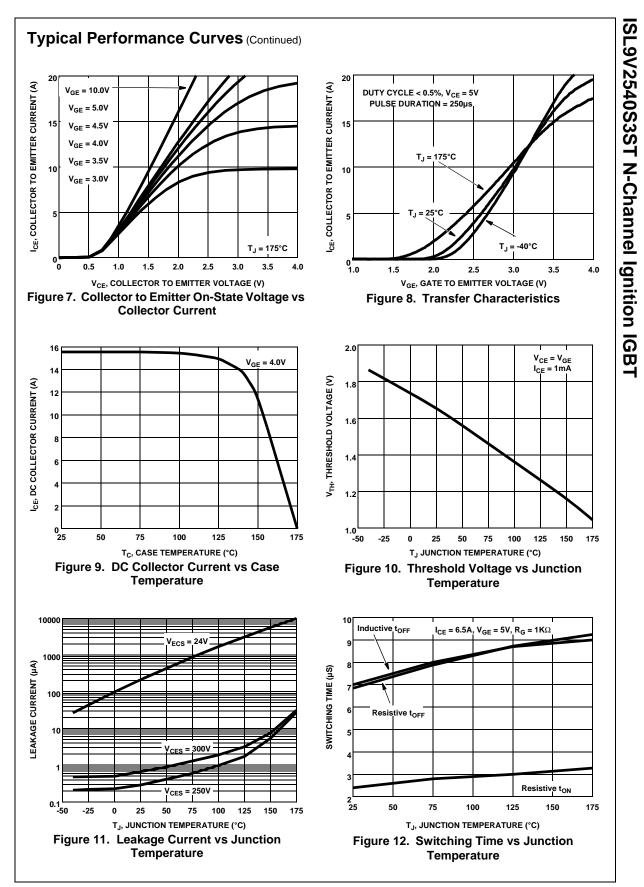
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Q <sub>G(ON)</sub>	Gate Charge	I <sub>C</sub> = 10A, V <sub>CE</sub> V <sub>GE</sub> = 5V, See		-	15.1	-	nC
V <sub>GE(TH)</sub>	Gate to Emitter Threshold Voltage	$I_{\rm C} = 1.0 {\rm mA},$	$T_{\rm C} = 25^{\circ}{\rm C}$	1.3	-	2.2	V
()		V <sub>CE</sub> = V <sub>GE,</sub> See Fig. 10	T <sub>C</sub> = 150°C	0.75	-	1.8	V
$V_{GEP}$	Gate to Emitter Plateau Voltage	I <sub>C</sub> = 10A, V <sub>CF</sub> = 12V		-	3.1	-	V
vitching	g Characteristics						
t <sub>d(ON)R</sub>	Current Turn-On Delay Time-Resistive	V <sub>CE</sub> = 14V, R <sub>L</sub>		-	0.61	-	μs
t <sub>riseR</sub>	Current Rise Time-Resistive	V <sub>GE</sub> = 5V, R <sub>G</sub> T <sub>.1</sub> = 25℃	= 1ΚΩ	-	2.17	-	μs
t <sub>d(OFF)</sub>	Current Turn-Off Delay Time-Inductive	V <sub>CE</sub> = 300V, L		-	3.64	-	μs
t <sub>fL</sub>	Current Fall Time-Inductive	V <sub>GE</sub> = 5V, R <sub>G</sub> T <sub>.1</sub> = 25°C, Se	= 1KΩ e Fig. 12	-	2.36	-	μs
SCIS	Self Clamped Inductive Switching	T <sub>J</sub> = 25°C, L = R <sub>G</sub> = 1KΩ, V <sub>0</sub> Fig. 1 & 2		-	-	250	mJ
ermal (	Characteristics	<u>1. ig. i di 2</u>			•		1
R <sub>AJC</sub>	Thermal Resistance Junction-Case	TO-263		-	_	0.9	°C/W
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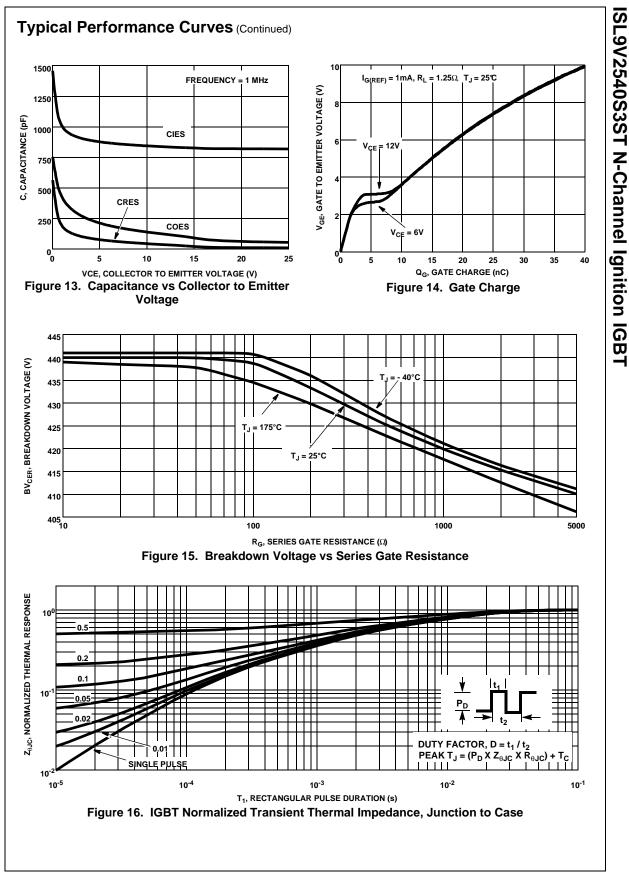
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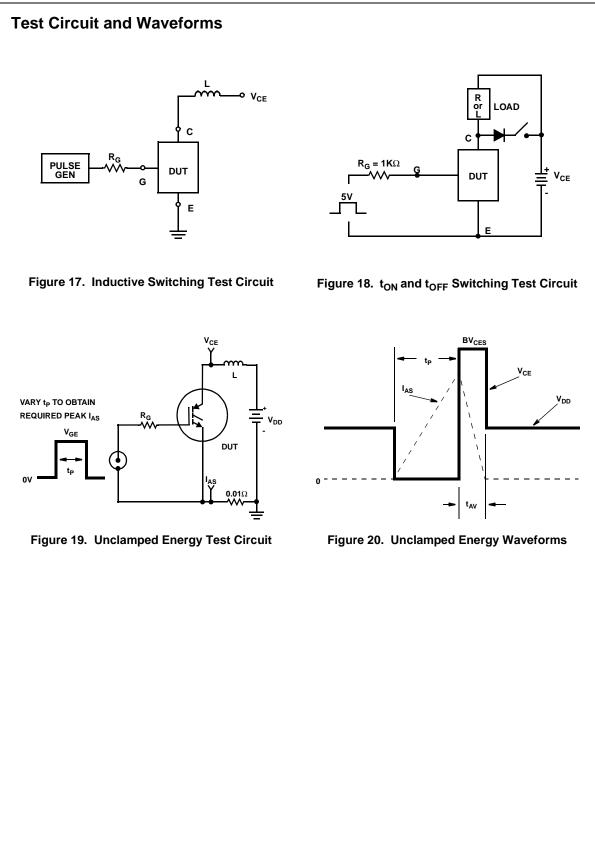
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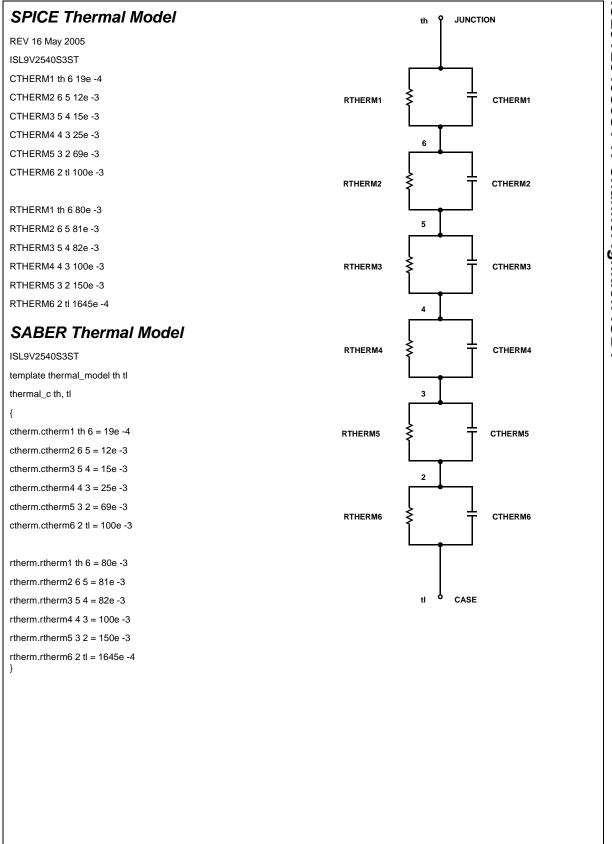


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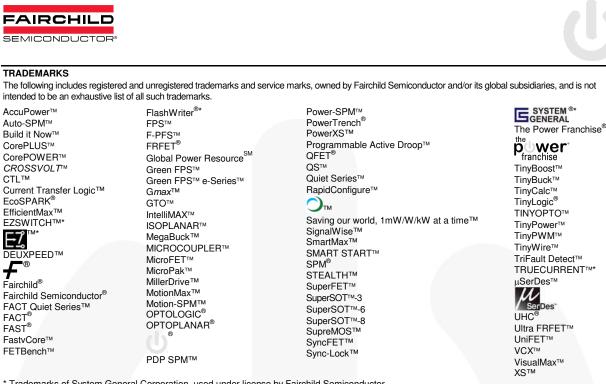


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ISL9V2540S3ST N-Channel Ignition IGBT



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